Name (Print/Type) | Winston Hsu

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PTO/SB/17 (12-04v2)

Date 1/24/2006

Approved for use through 07/31/2008. OMB 0651-0032 U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE Under the Paperwork Reduction Act of 1995 no persons are required to respond to a collection of information unless it displays a valid OMB control number Complete if Known Effective on 12/08/2004. Fees pursuant to the Consolidated Appropriations Act, 2005 (H.R. 4818). 10/604,687 **Application Number** FEE TRANSMITTAL 08/11/2003 Filing Date Kun-chih Lin For FY 2005 First Named Inventor GUERRERO, MARIA F **Examiner Name** Applicant claims small entity status. See 37 CFR 1.27 2822 Art Unit TOTAL AMOUNT OF PAYMENT ADTP0067USA (\$) 180.00 Attorney Docket No. METHOD OF PAYMENT (check all that apply) Credit Card L ___Money Order Check None 1 Other (please identify): Deposit Account Deposit Account Number: 50-3105 Deposit Account Name; North America Intellectual Property Corporation For the above-identified deposit account, the Director is hereby authorized to: (check all that apply) ✓ Charge fee(s) indicated below Charge fee(s) indicated below, except for the filing fee Charge any additional fee(s) or underpayments of fee(s) Credit any overpayments under 37 CFR 1.16 and 1.17 WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card Information and authorization on PTO-2038. **FEE CALCULATION** 1. BASIC FILING, SEARCH, AND EXAMINATION FEES SEARCH FEES FILING FEES **EXAMINATION FEES Small Entity** Small Entity Small Entity Fee (\$) Fees Paid (\$) **Application Type** Fee (\$) Fee (\$) Fee (\$) Fee (\$) 200 Utility 300 150 500 250 100 Design 200 130 100 100 50 65 Plant 200 160 100 300 150 80 600 300 300 500 250 Reissue 150 200 Provisional 0 0 100 0 0 Small Entity EXCESS CLAIM FEES Fee (\$) Fee (\$) Fee Description 25 Each claim over 20 (including Reissues) Each independent claim over 3 (including Reissues) **200** 100 180 360 Multiple dependent claims Multiple Dependent Claims Extra Claims Fee Paid (\$) Total Claims Fee (\$) Fee Paid (\$) Fee (\$) - 20 or HP = HP = highest number of total dalms paid for, if greater than 20. Fee Paid (\$) Extra Claims Indep. Claims Fee (\$) -3 or HP = HP = highest number of independent claims paid for, if greater than 3. 3. APPLICATION SIZE FEE If the specification and drawings exceed 100 sheets of paper (excluding electronically filed sequence or computer listings under 37 CFR 1.52(e)), the application size fee due is \$250 (\$125 for small entity) for each additional 50 sheets or fraction thereof. See 35 U.S.C. 41(a)(1)(G) and 37 CFR 1.16(s).

Total Sheets

Extra Sheets

Number of each additional 50 or fraction thereof Fee Paid (\$) (round up to a whole number) - 100 = 150 4. OTHER FEE(S) Fees Paid (\$) Non-English Specification, \$130 fee (no small entity discount) Other (e.g., late filing surcharge): submission of Information Disclosure Statement 180.00 SUBMITTED BY Registration No. broken town Hours Telephone 3027291562 Signature 41,526 (Attorney/Agent)

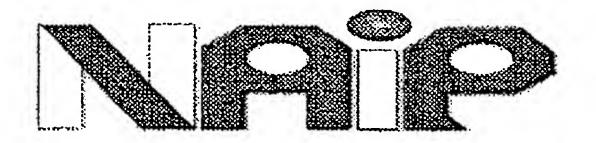
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Art Unit: 2822

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From: Winston Hsu, Registration No. 41,526

Serial No.: 10/604,687

Attorney Docket No.: ADTP0067USA

Subject: Information Disclosure Statement (IDS)

Total Pages: 26 pages (including cover page)

Winston Hsu 2006/01/24

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JAN 2 4 2006

Application Number

PTO/SB/21 (09-04)

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FORM				Filing Date	08/11/	08/11/2003			
					First Named Inventor	Kun-c	Kun-chih Lin		
					Art Unit	2822	2822		
(to be used for all correspondence after initial filing)				filing)	Examiner Name	GUER	SUERRERO, MARIA F		
Total Number of Pages in This Submission 25				25	Attorney Docket Number	ADTP	ADTP0067USA		
4 - 4	ENCLOSURES (Check all that apply)								
Fee Transmittal Form Fee Attached Amendment/Reply After Final Affidavits/declaration(s) Extension of Time Request Express Abandonment Request Information Disclosure Statement Certified Copy of Priority Document(s) Reply to Missing Parts/ Incomplete Application Reply to Missing Parts under 37 CFR 1.52 or 1.53			Terminal Disclaimer Request for Refund CD, Number of CD(s) Landscape Table on	o Convert to a lal Application Attorney, Revocation of Correspondence Address Disclaimer for Refund ber of CD(s)		After Allowance Communication to TC Appeal Communication to Board of Appeals and Interferences Appeal Communication to TC (Appeal Notice, Brief, Reply Brief) Proprietary Information Status Letter Other Enclosure(s) (please Identify below):			
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Firm Name North America Intellectual				ctual Prop	perty Corporation				
Signature William Com House				ex					
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Date 1/24/2006					Reg. No.	eg. No. 41,526			
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sufficient po	I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below: Signature Byww Cen								
Typed or printed name Byron Yen							Date	1/24/2006	
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This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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Substitute for form 1449/PTO				Complete if Known			
04421				Application Number	10/604,687		
18.1		N DIOOL A		Filing Date	08/11/2003		
	FORMATIO			First Named Inventor	Kun-chih Lin		
STATEMENT BY APPLICANT (Use as many sheets as necessary)				Art Unit	2822		
				Examiner Name	GUERRERO, MARIA F		
Sheet	<u>l</u>	of		Attorney Docket Number	ADTP0067USA		

			U.S. PATENT D	OCUMENTS	
Examiner initials*	Cite No.1	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Refevant Figures Appear
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Examiner Initials*	Cite No.1	Foreign Patent Document	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages	
		Country Code ² Number ⁴ "Gnd Code ⁵ (If known)	MM-DD-YYYY		Or Relevant Figures Appear	۲
	1	JP2000-150893	05-30-2000	NEC CORP.	all	1
	2	JP6-338614	12-06-1994	CASIO COMPUT CO LTD.	ali	-
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Examiner	Date	
Signature	Considered	

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 809. Draw line through citation if not in conformance and not considered, include copy of this form with next communication to applicant. Applicant's unique citation designation number (optional). 2 See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. 3 Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. Skind of document by the appropriate symbols as indicated on the document under WiPO Standard ST.16 if possible. 6 Applicant is to place a check mark here if English language Translation is attached.

This collection of information is required by 37 CFR 1.97 and 1.98. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND

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JAN 24 2006

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Kun-chih Lin

Appl. No.: 10/604,687

Filing Date: 08/11/2003

Examiner:

GUERRERO, MARIA F

Art Unit:

2822

Docket No.: ADTP0067USA

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Title:

METHOD OF FABRICATING POLYSILICON FILM BY EXCIMER

LASER CRYSTALLIZATION PROCESS

To:

Commissioner for Patents

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P.O. BOX 1450

Alexandria, VA 22313-1450

Subject: Information disclosure statement under 37 CFR \$1.56

20 Dear Sir or Madam,

This is an Information Disclosure Statement in accordance with the duty to disclose information material patentability under 37 CFR §1.56. The applicant wishes to make of record the documents listed on the accompanying PTO/SB/08 form.

Since this IDS is filed after the mailing date of final Office action but before payment of the issue fee, consideration of the information disclosure statement is 30 hereby requested according to 37 CFR \$1.97(d).

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Each item of information contained in the information disclosure statement was first cited in an Office communication mailed on December 09, 2005, which is no more than three months prior to the filing of this information disclosure statement, for the counterpart China patent application number 03141245.9. Accordingly, the submission fee of an information disclosure statement set forth in \$1.17(p) is enclosed to fulfill the requirement of \$1.97.

According to the requirement set forth in 37 CFR \$1.98, the applicant is submitting a copy of the cited Japan patent 2000-150893 (published May 30, 2000) and Japan patent H06-338614 (published December 6, 1994). The English-language titles and abstracts of Japan patent 2000-150893 and Japan patent H06-338614 are hereby presented to fulfill the 37 CFR \$1.98(a)(3) requirement.

The title and abstract of Japan patent 2000-150893 are listed as follows:

20 Title:

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THIN-FILM TRANSISTOR AND ITS MANUFACTURING METHOD

Abstract:

PROBLEM TO BE SOLVED: To provide a polysilicon TFT that has the superior transmittance at an opening, at the same time, can secure the flatness of wiring formation part even when cap annealing is made, and prevents the burnout of aluminum wiring, and its manufacturing method.

SOLUTION: In spolysilicon TFT, a silicon oxide film layer 11, a silicon nitride film layer 12, an amorphous silicon layer 13, and a cap layer 14 are laminated in this order, and excimer laser annealing (ELA) treatment is made via

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the cap layer, thus forming polysilicon 15. Also, in the polysilicon TFT, the silicon nitride film layer is eliminated by wet etching after excimer laser annealing.

The title and abstract of Japan patent H06-338614 are listed as follows:

Title:

THIN-FILM TRANSISTOR AND MANUFACTURE THEREOF

10 Abstract:

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PURPOSE: To avoid the formation of stepped part on a gate insulating film by a method wherein the gate insulating film is to be provided on the surface of a polysilicon film formed on a device area and a silicon oxide film formed on non-device area.

CONSTITUTION: An amorphous silicon film 13 is deposited on the surface of an underneath layer 12 to be implanted with oxygen ions using a resist film 15 as a mask so as to assume the amorphous silicon film 13 on the parts excluding the device area 14 as oxygen ion implanted film 13a. Next, the whole surface after releasing the resist film 15 is laser-annealed to crystallize the amorphous silicon film 13 on the part corresponding to the device area 14 to be turned into a polysilicon film. Besides, the oxygen ion implanted film 13a is oxidized to be turned into silicon oxide film whereon a gate insulating film is to be provided. Through these procedures, the formation of stepped part on the gate insulating film can be avoided thereby enabling the inconvenience due to the stepped part to be eliminated.

Claim 1 and claim 12 of the present invention have been

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amended in the response to Office action submitted with this IDS. The amended claims 1 and 12 are repeated here for reference.

Claim 1 (currently amended): A method of fabricating a polysilicon film by an excimer laser crystallization process, the method comprising following steps:

providing a substrate defined with a first region and a second region;

forming an amorphous silicon film on the substrate;

forming a mask layer on the amorphous silicon film;

performing a first photo-etching process to remove the

mask layer in the first region;

forming a heat-retaining capping layer covering the mask layer in the second region and the amorphous silicon film in the fist region; and

make the amorphous silicon film, covered by the heat-retaining capping layer, in the first region crystallize to a polysilicon film, using an excimer laser to irradiate the amorphous film to make the amorphous silicon film in the second region, which is covered with the mask layer, become partially melted and make the amorphous film in the first region, which is not covered with the mask layer, become completely melted, and grains are grown laterally toward the first region from the interface between the first region and the second region.

Claim 12 (currently amended): A method of fabricating a polysilicon film by an excimer laser crystallization process, the method comprising following steps:

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providing a substrate defined with a first region and a second region;

forming an amorphous silicon film on the substrate; forming a heat-retaining capping layer covering the amorphous silicon film in both of the first region and the second region;

forming a mask layer on the heat-retaining capping layer; performing a first photo-etching process to remove the mask layer in the first region and expose the heat-retaining capping layer in the first region; and performing the excimer laser crystallization process to make the amorphous silicon film, covered by the heat-retaining capping layer, in the first region crystallize to a polysilicon film, using an excimer laser to irradiate the amorphous film to make the amorphous silicon film in the second region, which is covered with the mask layer, become partially melted and make the amorphous film in the first region, which is not covered with the mask layer, become completely melted, and grains are grown laterally toward the first region from the interface between the first region and the second region.

According to Japan patent 2000-150893, an excimer laser annealing processing is performed via the cap layer 14 to form the polysilicon 15. However, Japan patent 2000-150893 does not teach forming a heat-retaining capping layer covering a mask layer in the second region and the amorphous silicon film in the fist region. Japan patent 2000-150893 does not mention utilizing a heat-retaining capping layer covering the amorphous silicon film for reducing heat dissipation rate to provide a high temperature environment in a longer time to

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re-crystallize the silicon film and to effectively improve the crystal gain sizes.

Furthermore, in the present invention, the amorphous silicon film in the first region is covered with a mask layer. When the amorphous film is irradiated by an excimer laser, the amorphous silicon film in the second region becomes partially melted and the amorphous film in the first region becomes completely melted, and grains are grown laterally toward the first region from the interface between the first region and the second region. Since Japan patent 2000-150893 does not disclose these limitations of the present invention, the applicant believes that the structure and the fabrication method of Japan patent 2000-150893 are significantly different from the present invention.

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According to Japan patent H06-338614, the amorphous silicon film 13, which is not covered with the mask layer, should be implanted with oxygen ions to be the oxygen ion implanted film 13a before the excimer laser annealing treatment. Then, the oxygen ion implanted film 13a is oxidized to be turned into silicon oxide film whereon a gate insulating film is to be provided. As the excimer laser crystallization process is performed, the amorphous silicon film 13 and the oxygen ion implanted film 13a are not covered by any mask layer or any heat-retaining capping layer. Japan patent H06-338614 does not mention utilizing a heat-retaining capping layer covering the amorphous silicon film for reducing heat dissipation rate to provide a high temperature environment in a longer time to re-crystallize the silicon film and to effectively improve the crystal gain sizes. The structure and the fabrication method of Japan patent H06-338614 are

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significantly different from the present invention.

Accordingly, although Japan patent 2000-150893 and Japan patent H06-338614 disclose methods of fabricating a polysilicon film by an excimer laser crystallization process, the applicant believes they are substantially different from the amended claim 1 and the amended claim 12 of the present invention, and a combination of the cited references still does not anticipate all limitations of these claims. Thus, the present invention is novel and unobvious.

It is respectfully requested that the Examiner consider the documents listed on the accompanying PTO/SB/08 form and that it be made of record in the application. The applicant hopes that the Examiner can initial the cited references on the form and that a copy of the initialed form be sent to the applicant with the next communication from the Examiner.

Respectfully submitted,

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Date: January 23, 2006

Winston Hsu, Patent Agent No. 41,526

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